Silicon P Channel MOS Type (U-MOSII)/Silicon Epitaxial Schottky Barrier Diode

SSM5G02TU

DC-DC Converter

Unit: mm

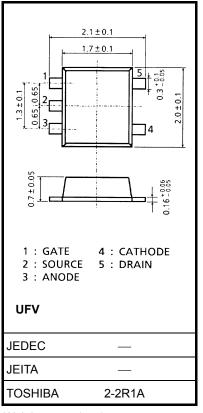
- Combined Pch MOSFET and Schottky Diode into one Package.
- Low RDS (ON) and Low VF

Absolute Maximum Ratings (Ta = 25°C) MOSFET

Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		V_{DS}	-12	V	
Gate-Source voltage		V_{GSS}	±12	٧	
Drain current	DC	ΙD	-1.0	Α	
	Pulse	I _{DP} (Note 2)	-2.0	ζ	
Drain power dissipation		P _D (Note 1)	0.5	W	
		t = 10s	0.8	VV	
Channel temperature		T _{ch}	150	°C	

Absolute Maximum Ratings (Ta = 25°C) SCHOTTKY DIODE

Characteristics	Symbol	Rating	Unit
Maximum (peak) reverse voltage	V_{RM}	15	V
Reverse voltage	V_{R}	12	V
Average forward current	Io	0.5	Α
Peak one cycle surge forward current (non-repetitive)	I _{FSM}	2 (50 Hz)	Α
Junction temperature	Tj	125	°C



Weight: 7 mg (typ.)

Absolute Maximum Ratings (Ta = 25°C) MOSFET, DIODE COMMON

Characteristics	Symbol	Rating	Unit
Storage temperature	T _{stg}	-55~125	°C
Operating temperature	T _{opr} (Note 3)	−40~85	°C

Note:

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on FR4 board

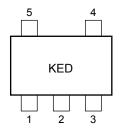
 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ t}, \text{ Cu pad: } 645 \text{ mm}^2)$

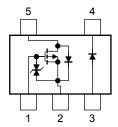
Note 2: The pulse width limited by max channel temperature.

Note 3: Operating temperature limited by max channel temperature and max junction temperature.

Marking

Equivalent Circuit





Handling Precaution

When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic discharge. Operators should wear anti-static clothing and use containers and other objects that are made of anti-static materials.

The Channel-to-Ambient thermal resistance R_{th} (ch-a) and the drain power dissipation P_D vary according to the board material, board area, board thickness and pad area. When using this device, please take heat dissipation fully into account.

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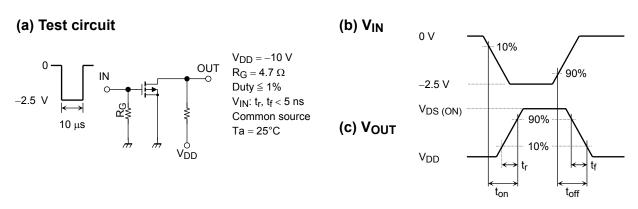
MOSFET

Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage curre	ent	I _{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$	_	_	±1	μА
Drain-Source breakdown voltage		V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0$	-12	_	_	V
		V (BR) DSX	$I_D = -1 \text{ mA}, V_{GS} = +8 \text{ V}$	-4	_	_	
Drain Cut-off currer	nt	I _{DSS}	$V_{DS} = -12 \text{ V}, V_{GS} = 0$	_	_	-1	μА
Gate threshold voltage		V_{th}	$V_{DS} = -3V$, $I_D = -0.1$ mA	-0.4	_	-1.1	V
Forward transfer admittance		Y _{fs}	$V_{DS} = -3 \text{ V}, I_D = -0.5 \text{ A}$ (Note 4)	1.3	2.5	_	S
Drain-Source ON resistance		R _{DS (ON)}	$I_D = -0.5 \text{ A}, V_{GS} = -4 \text{ V}$ (Note 4)	_	125	160	mΩ
			$I_D = -0.5 \text{ A}, V_{GS} = -2.5 \text{ V}$ (Note 4)	_	180	240	1112.2
Input capacitance		C _{iss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	310	_	pF
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	70	_	pF
Output capacitance		Coss	$V_{DS} = -10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	110	_	pF
Switching time	Turn-on time	t _{on}	$V_{DD} = -10 \text{ V}, I_D = -0.5 \text{ A}$	_	20	_	ns
	Turn-off time	t _{off}	$V_{GS} = 0 \sim -2.5 \text{ V}, R_G = 4.7 \Omega$	_	32	_	115

Note 4: Pulse measurement

Switching Time Test Circuit



Precaution

 V_{th} can be expressed as voltage between gate and source when low operating current value is I_D = $-100~\mu A$ for this product. For normal switching operation, V_{GS} (on) requires higher voltage than V_{th} and V_{GS} (off) requires lower voltage than V_{th} .

(Relationship can be established as follows: V_{GS} (off) < V_{th} < V_{GS} (on))

Please take this into consideration for using the device.

Schottky Diode

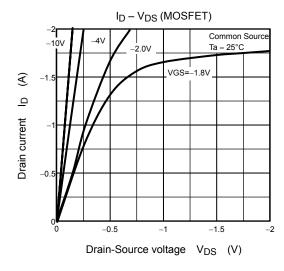
Electrical Characteristics (Ta = 25°C)

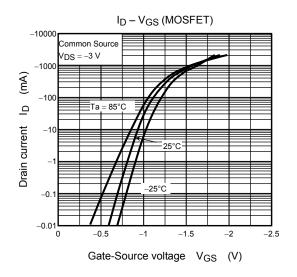
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _{F (1)}	I _F = 0.3 A	_	0.33	0.39	V
	V _{F (2)}	I _F = 0.5 A	_	0.37	0.43	V
Reverse current	I _R	V _R = 12 V	_	_	100	μА
Total capacitance	C _T	$V_R = 0 V, f = 1 MHz$	_	80		pF

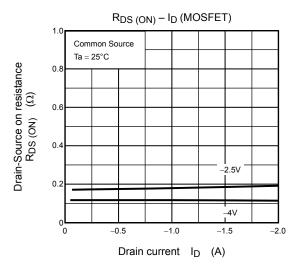
Precaution

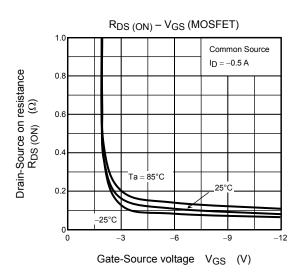
The schottky barrier diode of this product are having large-reverse-current-leakage characteristic compare to the other switching diodes. This current leakage and not proper operating temperature or voltage may cause thermal runaway. Please take forward and reverse loss into consideration when you design.

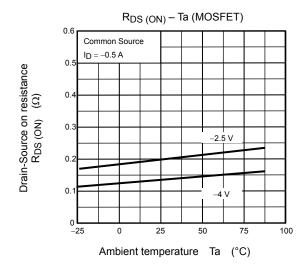
MOSFET Electrical Characteristics Graph

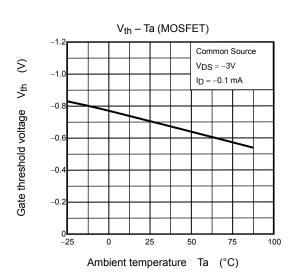




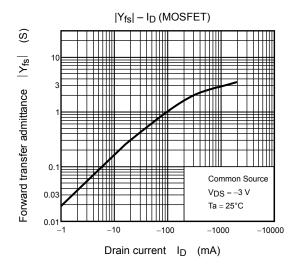


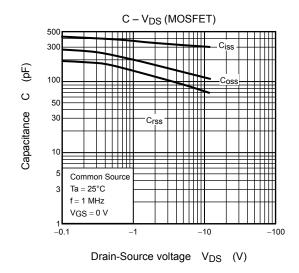


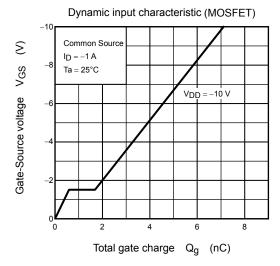


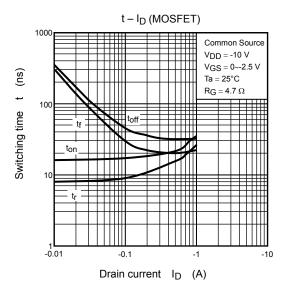


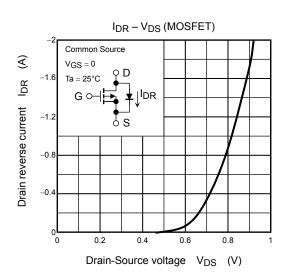
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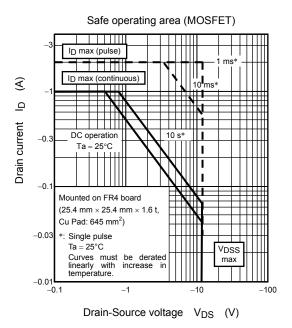


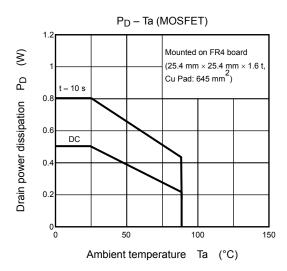




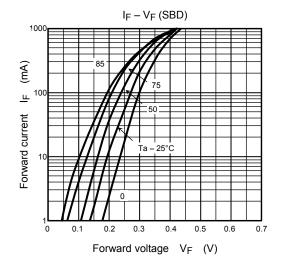


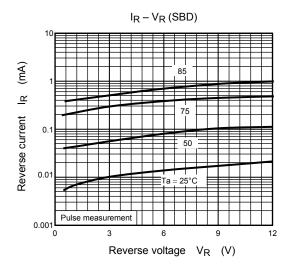
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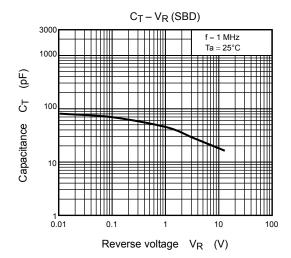




SBD Electrical Characteristics Graph

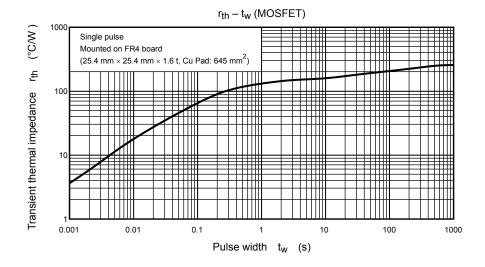


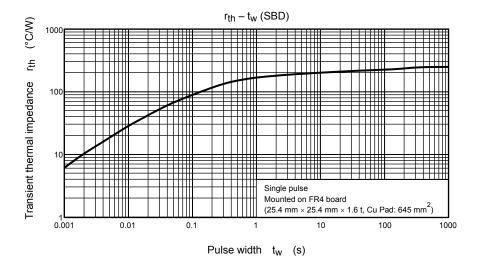




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Transient thermal impedance Graph





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